#### 查询SN74CBT162292DGG供应商

# 捷多邦,专业PCB打样工厂,24小时加**会和订集CBT162292** 12-BIT 1-OF-2 FET MULTIPLEXER/DEMULTIPLEXER WITH INTERNAL PULLDOWN RESISTORS SCDS052C - MARCH 1998 - REVISED MAY 1998

- **TTL-Compatible Control Input Levels**
- Isolation Under Power-Off Conditions
- Make-Before-Break Feature
- Internal 500-Ω Pulldown Resistors to Ground
- **A-Port Inputs/Outputs Have Equivalent 25-**Ω Series Resistors, So No External **Resistors Are Required**
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and 300-mil Shrink Small-Outline (DL) Packages

#### description

The SN74CBT162292 is a 12-bit 1-of-2 high-speed TTL-compatible FET multiplexer/ demultiplexer. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

When the select (S) input is low, port A is connected to port B1 and R<sub>INT</sub> is connected to port B2. When S is high, port A is connected to port B2 and RINT is connected to port B1.

The A-port inputs/outputs include equivalent  $25-\Omega$ series resistors to reduce overshoot and undershoot.

The SN74CBT162292 is characterized for WWW.DZSG.CO operation from -40°C to 85°C.

FUNCTION TABLE				
S FUNCTION				
L	A port = B1 port R <sub>INT</sub> = B2 port			
н	A port = B2 port RINT = B1 port			

,	DGG, DGV, OR DL PACKAGE (TOP VIEW)					
		50				
sL		56	I NC			
1A [	2	55	NC			
NC			E			
2A 🛛		53	6			
NC	5	52	2B1			
3A L		51	2B2			
NC	7	50	3B1			
GND	8	49	GND			
4A 🛛	9	48	3B2			
NC [	10	47	4B1			
5A 🛛	11	46	] 4B2			
NC [	12	45				
6A 🛛	13	44	5B2			
NC	14	43	]6B1			
7A 🛛	15	42	]6B2			
NC	16	41	<b>]</b> 7B1			
v <sub>cc</sub> [	17	40	7B2			
8A [	18	39	8B1			
GND	19	38	<b>I</b> GND			
NC 🛛	20	37	8B2			
9A [	21	36	9B1			
NC [	22	35	9B2			
10A 🛛	23	34	10B1			
NC	24	33	10B2			
11A	and the second second	32	11B1			
NC	26	31	11B2			
12A	27	30	12B1			
NC	28	29	12B1			

NC - No internal connection

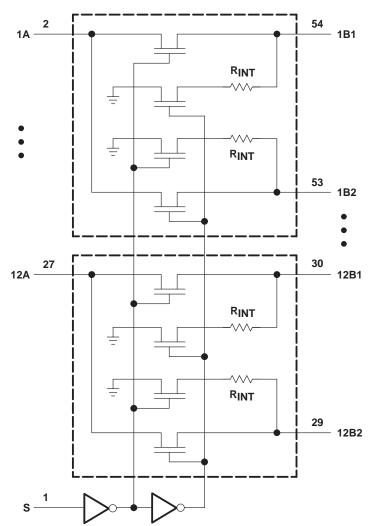


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### SN74CBT162292 12-BIT 1-OF-2 FET MULTIPLEXER/DEMULTIPLEXER WITH INTERNAL PULLDOWN RESISTORS SCDS052C - MARCH 1998 - REVISED MAY 1998

# logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

	0.5 V t	
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)		50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2):	DGG package 81	°C/W
	DGV package 86	°C/W
	DL package 74	l°C/W
Storage temperature range, T <sub>stg</sub>		150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



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#### recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2		V
VIL	Low-level control input voltage		0.8	V
Т <sub>А</sub>	Operating free-air temperature	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER		TEST CONDITION	ONS	MIN	TYP†	MAX	UNIT
VIK		V <sub>CC</sub> = 4.5 V,	l <sub>l</sub> = –18 mA				-1.2	V
Ц		V <sub>CC</sub> = 5.5 V,	$V_I = V_{CC} \text{ or } GND$				±5	μΑ
loff		$V_{CC} = 0,$	$V_{I} \text{ or } V_{O} = 0 \text{ to } 7 \text{ V}$				10	μΑ
ICC		V <sub>CC</sub> = 5.5 V,	I <sub>O</sub> = 0,	$V_I = V_{CC}$ or GND			3	μΑ
∆lCC‡	Control input	V <sub>CC</sub> = 5.5 V,	One input at 3.4 V,	Other inputs at $V_{CC}$ or GND			2.5	mA
Ci	Control input	V <sub>I</sub> = 3 V or 0				3.5		pF
C <sub>io</sub>		$V_{CC} = 0,$	$V_{O} = 3 V \text{ or } 0$			8		pF
		$V_{CC} = 4 V$ , TYP at $V_{CC} = 4 V$	V <sub>I</sub> = 2.4 V,	I <sub>I</sub> = 15 mA		38	55	
ron§			$V_{I} = 0$	lı = 45 mA		39	63	Ω
		$V_{CC} = 4.5 V$	vI=0	Ij = 30 mA		37	55	
			V <sub>I</sub> = 2.4 V,	lj = 15 mA		37	55	

<sup>†</sup> All typical values are at  $V_{CC}$  = 5 V (unless otherwise noted),  $T_A$  = 25°C.

<sup>‡</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

§ Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

### switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF, (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> :	= 4 V	= V <sub>CC</sub> ± 0.5	= 5 V 5 V	UNIT
		(001F01)	MIN	MAX	MIN	MAX	
t <sub>pd</sub> ¶	A or B	B or A		1.9		1.85	ns
ten	S	A or B	1	10.7	1	9.5	ns
<sup>t</sup> dis	S	A or B	1	10.9	1	9.7	ns

The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

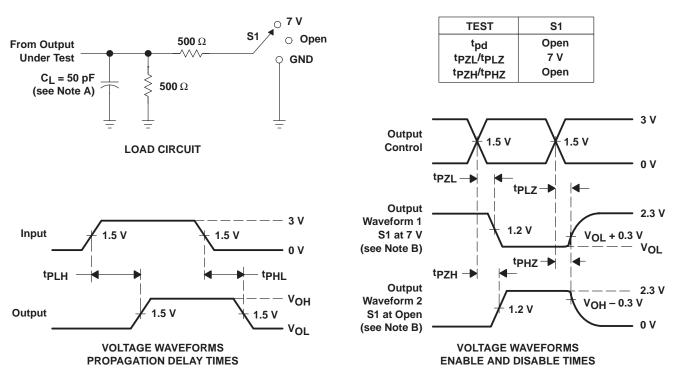
#### switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ , (unless otherwise noted) (see Figure 1)

PARAMETER	DESCRIPTION		= 4 V	= ۷ <sub>CC</sub> ± 0.	UNIT	
			MAX	MIN	MAX	
t <sub>mbb</sub> #	Make-before-break time	0	2	0	2	ns

<sup>#</sup>The make-before-break time is the time interval between make and break, during the transition from one selected port to the other.



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#### PARAMETER MEASUREMENT INFORMATION

- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when connected to the internal 500-Ω pulldown resistor. Waveform 2 is for an output with internal conditions such that the output is high except when connected to the internal 500-Ω pulldown resistor.
  - C. All pulse inputs and DC inputs are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>Q</sub> = 50  $\Omega$ ,  $t_r \le 2.5$  ns,  $t_f \le 2.5$  ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  $Z = R_{INT} = 500 \Omega$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  $Z = R_{INT} = 500 \Omega$ .
  - G. tPLH and tPHL are the same as tpd.

#### Figure 1. Load Circuit and Voltage Waveforms



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